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## 16-Bit, 250kSPS, Serial, CMOS, Sampling ANALOG-TO-DIGITAL CONVERTER

Check for Samples: ADS8519

#### **FEATURES**

- 0V to 8.192V, ±5V, and ±10V Input Ranges
- 93dB SNR with 20kHz Input
- ±1.5LSB Max INL
- ±1LSB Max DNL; 16 Bits, No Missing Codes
- SPI™-Compatible Serial Output with Daisy-Chain (TAG) Feature and 3-State Bus
- 5V Analog Supply, 1.65V to 5.25V I/O Supply
- Pinout Similar to 16-Bit ADS7809 (Low-Speed) and 12-Bit ADS7808 and ADS8508
- No External Precision Resistors Required
- **Uses Internal or External Reference**
- 110mW Typ Power Dissipation at 250kSPS
- 28-Pin SSOP Package
- Simple DSP Interface

#### **APPLICATIONS**

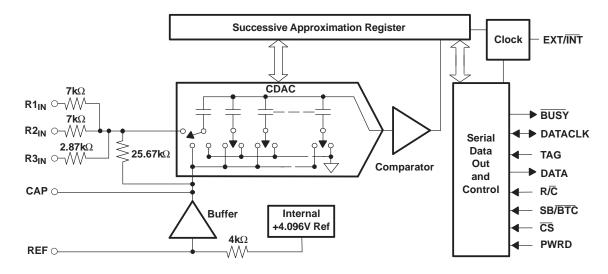
- **Industrial Process Control**
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#### DESCRIPTION

The ADS8519 is a complete 16-bit sampling analog-to-digital (A/D) converter using state-of-the-art CMOS structures. It contains a complete 16-bit, capacitor-based, successive approximation register (SAR) A/D converter with sample-and-hold, reference, clock, and a serial data interface. Data can be output using the internal clock or synchronized to an external data clock. The ADS8519 also provides an output synchronization pulse for ease-of-use with standard DSP processors.

The ADS8519 is specified at a 250kSPS sampling rate over the full temperature range. Internal precision resistors provide various input ranges including ±10V, ±5V, and 0V to 8.192V, while the innovative design allows operation from a single 5V supply with power dissipation under 125mW.

The ADS8519 is available in a 28-pin SSOP package, and is fully specified for operation over the industrial -40°C to +85°C temperature range.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### PACKAGE/ORDERING INFORMATION(1)

| PRODUCT    | MINIMUM<br>INL<br>(LSB) | NO<br>MISSING<br>CODES | MINIMUM<br>SINAD<br>(dB) | SPECIFIED<br>TEMPERATURE<br>RANGE | PACKAGE-<br>LEAD | PACKAGE<br>DESIGNATOR | ORDERING<br>NUMBER | TRANSPORT<br>MEDIA, QTY |
|------------|-------------------------|------------------------|--------------------------|-----------------------------------|------------------|-----------------------|--------------------|-------------------------|
| ADS8519IB  | ±1.5                    | 16-Bit                 | 90                       | -40°C to +85°C                    | SSOP-28          | DB                    | ADS8519IBDB        | Tube, 50                |
| AD303191B  | ±1.5                    | 10-011                 | 90                       | -40 C to +65 C                    | 330F-20          | DB                    | ADS8519IBDBR       | Tape and Reel, 2000     |
| ADS8519I   | . 2                     | 15-Bit                 | 07                       | -40°C to +85°C                    | SSOP-28          | DB                    | ADS8519IDB         | Tube, 50                |
| AD 983 191 | ±3                      | 10-Bil                 | 0/                       | 87 –40°C to +85°C                 |                  | DB                    | ADS8519IDBR        | Tape and Reel, 2000     |

<sup>(1)</sup> For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

## ABSOLUTE MAXIMUM RATINGS(1) (2)

Over operating free-air temperature range (unless otherwise noted).

|                              |                  | UNIT                                     |
|------------------------------|------------------|--|
|                              | R1 <sub>IN</sub> | ±25V                                     |
| Analog inputs                | R2 <sub>IN</sub> | ±25V                                     |
| Analog inputs                | R3 <sub>IN</sub> | ±25V                                     |
|                              | REF              | +V <sub>ANA</sub> + 0.3V to AGND2 - 0.3V |
|                              | DGND, AGND2      | ±0.3V                                    |
| Ground voltage differences   | V <sub>ANA</sub> | 6V                                       |
|                              | $V_{DIG}$        | 6V                                       |
| Digital inputs               |                  | -0.3V to +V <sub>DIG</sub> + 0.3V        |
| Internal power dissipation   |                  | 700mW                                    |
| Maximum junction temperature | 9                | +165°C                                   |
| Lead temperature (soldering, | 10s)             | +300°C                                   |

<sup>(1)</sup> Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

At  $T_A = -40^{\circ}$ C to +85°C,  $f_S = 250$ kSPS, and  $V_{DIG} = V_{ANA} = 5V$ , using internal reference (unless otherwise specified).

| A                             | TOTAL OF THE TOTAL TANK | ,   |         | ,   |     |          | /   |      |
|-------------------------------|-------------------------|-----|---------|-----|-----|----------|-----|------|
|                               |                         | Α   | DS8519I |     | Α   | DS8519IB |     |      |
| PARAMETER                     | TEST CONDITIONS         | MIN | TYP     | MAX | MIN | TYP      | MAX | UNIT |
| Resolution                    |                         |     |         | 16  |     |          | 16  | Bits |
| ANALOG INPUT                  |                         |     |         |     |     |          |     |      |
| Voltage ranges <sup>(1)</sup> |                         |     |         |     |     |          |     |      |
| Impedance <sup>(1)</sup>      |                         |     |         |     |     |          |     |      |
| Capacitance                   |                         |     | 50      |     |     | 50       |     | pF   |
| THROUGHPUT SPEED              |                         |     |         |     |     |          |     |      |
| Conversion cycle time         | Acquire and convert     |     |         | 4   |     |          | 4   | μS   |
| Throughput rate               |                         | 250 |         |     | 250 |          |     | kSPS |

Product Folder Link(s): ADS8519

(1) ±10V, ±5V, 0V to 8.192V, etc. (see Table 2)

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<sup>(2)</sup> All voltage values are with respect to network ground terminal.



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### **ELECTRICAL CHARACTERISTICS (continued)**

At  $T_A = -40^{\circ}$ C to +85°C,  $f_S = 250$ kSPS, and  $V_{DIG} = V_{ANA} = 5V$ , using internal reference (unless otherwise specified).

|        |  |                                    | BPS, and V <sub>DIG</sub> = V <sub>ANA</sub> = |       | DS8519I | ,     |       | DS8519IB |       |                    |
|--------|--|------------------------------------|--|-------|---------|-------|-------|----------|-------|--------------------|
|        | PARAME   | TER                                | TEST CONDITIONS                                | MIN   | TYP     | MAX   | MIN   | TYP      | MAX   | UNIT               |
| DC ACC | CURACY   |                                    | !  |       |         |       |       |          |       |                    |
| INL    | Integral linearit  | y error                            |  | -3    |         | 3     | -1.5  |          | 1.5   | LSB <sup>(2)</sup> |
| DNL    | Differential line  | arity error                        |  | -2    |         | 2     | -1    |          | 1     | LSB                |
|        | Differential linearity error  No missing codes                                   |                                    |  | 15    |         |       | 16    |          |       | Bits               |
|        | Transition noise   | e <sup>(3)</sup>                   |  |       | 0.67    |       |       | 0.67     |       | LSB                |
|        | Full-scale   | ±10V range                         | Internal reference                             | -0.5  |         | 0.5   | -0.25 |          | 0.25  |                    |
|        | error <sup>(4) (5)</sup>   | All other ranges                   | Internal reference                             | -0.5  | -0.05   | 0.5   | -0.5  | -0.05    | 0.5   | %FSR               |
|        | Full-scale error   | drift                              | Internal reference                             |       | ±7      |       |       | ±7       |       | ppm/°C             |
|        | Full-scale   | ±10V range                         | External reference                             | -0.05 | 0.003   | 0.05  | -0.05 | 0.003    | 0.05  |                    |
|        | error <sup>(4) (5)</sup>   | All other ranges                   | External reference                             | -0.5  |         | 0.5   | -0.5  |          | 0.5   | %FSR               |
|        | Full-scale error   | drift                              | External reference                             |       | ±2      |       |       | ±2       |       | ppm/°C             |
|        | Bipolar zero er  | ror <sup>(4)</sup>                 |  | -4    |         | 4     | -2    |          | 2     | mV                 |
|        | Bipolar zero er  | ror drift                          |  |       | ±2      |       |       | ±2       |       | ppm/°C             |
|        | Unipolar zero error <sup>(4)</sup>   | 8.192V                             |  | -20   | 6       | 20    | -20   | 6        | 20    | mV                 |
|        | Unipolar zero e  | error drift                        |  |       | ±0.4    |       |       | ±0.4     |       | ppm/°C             |
|        | Recovery to rat  | ted accuracy after                 | 1μF capacitor to CAP                           |       | 1       |       |       | 1        |       | ms                 |
|        | Power supply sensitivity (V <sub>DIG</sub> = V <sub>ANA</sub> = V <sub>D</sub> ) |                                    | +4.75V < V <sub>D</sub> < +5.25V               | -8    |         | 8     | -8    |          | 8     | LSB                |
| AC ACC | CURACY   |                                    |  |       |         | -     |       |          |       |                    |
| SFDR   | Spurious-free of   | lynamic range                      | $f_I = 20kHz$                                  | 95    | 100     |       | 97    | 100      |       | dB <sup>(6)</sup>  |
| THD    | Total harmonic   | distortion                         | f <sub>I</sub> = 20kHz                         |       | -96     | -94   |       | -98      | -96   | dB                 |
| 011145 |  |                                    | f <sub>I</sub> = 20kHz                         | 87    | 91      |       | 90    | 92       |       | dB                 |
| SINAD  | Signal-to-(noise   | e+distortion)                      | -60dB Input                                    |       | 30      |       |       | 32       |       | dB                 |
| SNR    | Signal-to-noise  | ratio                              | f <sub>I</sub> = 20kHz                         | 88    | 92      |       | 91    | 93       |       | dB                 |
|        | Full-power ban   | dwidth <sup>(7)</sup>              |  |       | 500     |       |       | 500      |       | kHz                |
| SAMPL  | ING DYNAMICS   |                                    |  |       |         |       |       |          |       |                    |
|        | Aperture delay   |                                    |  |       | 5       |       |       | 5        |       | ns                 |
|        | Transient respo  | onse                               | FS step  |       |         | 2     |       |          | 2     | μS                 |
|        | Overvoltage re   | covery <sup>(8)</sup>              |  |       | 150     |       |       | 150      |       | ns                 |
| REFERE | ENCE   |                                    |  |       |         |       |       |          |       |                    |
|        | Internal referen   | ice voltage                        | No load  | 4.076 | 4.096   | 4.116 | 4.076 | 4.096    | 4.116 | V                  |
|        | Internal referen<br>(must use exte   | ice source current<br>rnal buffer) |  |       | 1       |       |       | 1        |       | μА                 |
|        | Internal referen   | ice drift                          |  |       | 8       |       |       | 8        |       | ppm/°C             |
|        | External refere  | nce voltage range earity           |  | 3.9   | 4.096   | 4.2   | 3.9   | 4.096    | 4.2   | ٧                  |
|        | External refere  | nce current drain                  | External 4.096V ref.                           |       |         | 100   |       |          | 100   | μА                 |

- 2) LSB means Least Significant Bit. For the  $\pm 10 \text{V}$  input range, one LSB is  $305 \mu\text{V}$ .
- (3) Typical rms noise at worst-case transitions and temperatures.
- (4) As measured with circuit shown in Figure 29 and Figure 30.
- (5) For bipolar input ranges, full-scale error is the worst case of –Full-Scale or +Full-Scale uncalibrated deviation from ideal first and last code transitions, divided by the transition voltage (not divided by the full-scale range) and includes the effect of offset error. For unipolar input ranges, full-scale error is the deviation of the last code transition divided by the transition voltage. It also includes the effect of offset error.
- (6) All specifications in dB are referred to a full-scale ±10V input.
- 7) Full-power bandwidth is defined as the full-scale input frequency at which signal-to-(noise + distortion) degrades to 60dB.
- (8) Recovers to specified performance after 2 x FS input overvoltage.



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### **ELECTRICAL CHARACTERISTICS (continued)**

At  $T_A = -40^{\circ}$ C to +85°C,  $f_s = 250$ kSPS, and  $V_{DIG} = V_{ANA} = 5$ V, using internal reference (unless otherwise specified).

|                  |  |  | ADS8519I                    |                            |                        | ΑI                      | OS8519IB                  |                        |      |
|------------------|--|--|-----------------------------|----------------------------|------------------------|-------------------------|---------------------------|------------------------|------|
|                  | PARAMETER  | TEST CONDITIONS  | MIN                         | TYP                        | MAX                    | MIN                     | TYP                       | MAX                    | UNIT |
| DIGITA           | AL INPUTS  |  | •                           |                            |                        |                         |                           |                        |      |
|                  | Logic levels   |  |                             |                            |                        |                         |                           |                        |      |
| V <sub>IL</sub>  | Low-level input voltage (9)  | $V_{DIG} = 1.65V \text{ to } 5.25V$  | -0.3                        |                            | 0.6                    | -0.3                    |                           | 0.6                    | V    |
| V <sub>IH</sub>  | High-level input voltage <sup>(9)</sup>  | V <sub>DIG</sub> = 1.65V to 5.25V  | 0.5 x V <sub>DIG</sub>      |                            | V <sub>DIG</sub> + 0.3 | 0.5 x V <sub>DIG</sub>  |                           | V <sub>DIG</sub> + 0.3 | V    |
| I <sub>IL</sub>  | Low-level input current  | V <sub>IL</sub> = 0V   |                             |                            | ±10                    |                         |                           | ±10                    | μА   |
| I <sub>IH</sub>  | High-level input current   | V <sub>IH</sub> = 5V   |                             |                            | ±10                    |                         |                           | ±10                    | μΑ   |
| DIGITA           | AL OUTPUTS   |  |                             |                            |                        |                         |                           |                        |      |
|                  | Data format  |  | Ser                         | ial, 16-bits               |                        | Ser                     | ial, 16-bits              |                        |      |
|                  | Data coding  |  |                             | 's complemaight binar      |                        |                         | 2's compler<br>aight bina |                        |      |
|                  | Pipeline delay   |  | Conversion re<br>after comp | esults only<br>eleted conv |                        | Conversion r            |                           |                        |      |
|                  | Data clock   |  |                             | ble for inter              |                        |                         | ble for inte              |                        |      |
|                  | Internal clock (output only when transmitting data)                              | EXT/INT low  |                             | 9                          |                        |                         | 9                         |                        | MHz  |
|                  | External clock (can run continually but not recommended for optimum performance) | EXT/INT high   | 0.1                         |                            | 26                     | 0.1                     |                           | 26                     | MHz  |
| V <sub>OL</sub>  | Low-level output voltage   | $I_{SINK} = 1.6 \text{mA},$<br>$V_{DIG} = 1.65 \text{V to } 5.25 \text{V}$ |                             |                            | 0.45                   |                         |                           | 0.45                   | V    |
| V <sub>OH</sub>  | High-level output voltage  | $I_{SOURCE} = 500 \mu A,$<br>$V_{DIG} = 1.65 V \text{ to } 5.25 V$         | V <sub>DIG</sub> – 0.45     |                            |                        | $V_{\text{DIG}} - 0.45$ |                           |                        | V    |
|                  | Leakage current  | Hi-Z state,<br>V <sub>OUT</sub> = 0V to V <sub>DIG</sub>                   |                             |                            | ±5                     |                         |                           | ±5                     | μА   |
|                  | Output capacitance   | Hi-Z state   |                             |                            | 15                     |                         |                           | 15                     | pF   |
| POWE             | R SUPPLIES   |  |                             |                            |                        |                         |                           |                        |      |
| $V_{DIG}$        | Digital input voltage  | Must be ≤ V <sub>ANA</sub>   | 1.65                        |                            | 5.25                   | 1.65                    |                           | 5.25                   | ٧    |
| V <sub>ANA</sub> | Analog input voltage   | Must be ≤ V <sub>ANA</sub>   | 4.75                        | 5                          | 5.25                   | 4.75                    | 5                         | 5.25                   | V    |
| l <sub>DIG</sub> | Digital input current  | Must be ≤ V <sub>ANA</sub>   |                             | 0.1                        | 1                      |                         | 0.1                       | 1                      | mA   |
| I <sub>ANA</sub> | Analog input current   | Must be ≤ V <sub>ANA</sub>   |                             | 22                         | 25                     |                         | 22                        | 25                     | mA   |
| POWE             | R DISSIPATION  |  |                             |                            |                        |                         |                           |                        |      |
|                  | PWRD Low   | f <sub>S</sub> = 250kSPS   |                             | 110                        | 125                    |                         | 110                       | 125                    | mW   |
|                  | PWRD High  |  |                             | 20                         |                        |                         | 20                        |                        | μW   |
| TEMP             | ERATURE RANGE  |  |                             |                            |                        |                         |                           |                        |      |
|                  | Specified performance  |  | -40                         |                            | +85                    | -40                     |                           | +85                    | °C   |
|                  | Derated performance <sup>(10)</sup>  |  | -55                         |                            | +125                   | <b>-</b> 55             |                           | +125                   | °C   |
|                  | Storage  |  | -65                         |                            | +150                   | -65                     |                           | +150                   | °C   |
| $\theta_{JA}$    | Thermal resistance   |  |                             | 67                         |                        |                         | 67                        |                        | °C/W |

<sup>(9)</sup> TTL-compatible at 5V supply.

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<sup>(10)</sup> The internal reference may not be started correctly beyond the industrial temperature range (-40°C to +85°C); therefore, use of an external reference is recommended.



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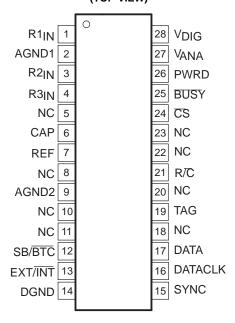


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### **PIN CONFIGURATION**

# DB PACKAGE (TOP VIEW)





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### **Pin Assignments**

| PIN              |                                    |     |  |  |  |  |  |  |
|------------------|------------------------------------|-----|--|--|--|--|--|--|
| NAME             | NO.                                | I/O | DESCRIPTION  |  |  |  |  |  |
| AGND1            | 2                                  | ı   | Analog ground. Used internally as ground reference point. Minimal current flow.  |  |  |  |  |  |
| AGND2            | 9                                  | ı   | Analog ground  |  |  |  |  |  |
| BUSY             | 25                                 | 0   | Busy output. Falls when a conversion is started, and remains low until the conversion is completed and the data are latched into the output shift register.  |  |  |  |  |  |
| CS               | 24                                 | ı   | Chip select. Internally ORed with $R/\overline{C}$ .   |  |  |  |  |  |
| CAP              | 6                                  |     | Reference buffer capacitor, 2.2µF tantalum capacitor to ground.  |  |  |  |  |  |
| DATA             | 17                                 | 0   | Serial data output. Data are synchronized to DATACLK, with the format determined by the level of SB/BTC. In the external clock mode, after 16 bits of data, the ADS8519 outputs the level input on TAG as long as $\overline{\text{CS}}$ is low and R/ $\overline{\text{C}}$ is high (see Figure 8 and Figure 9). If EXT/ $\overline{\text{INT}}$ is low, data are valid on both the rising and falling edges of DATACLK, and between conversions DATA stays at the level of the TAG input when the conversion was started.  |  |  |  |  |  |
| DATACLK          | 16                                 | I/O | Either an input or an output, depending on the EXT/INT level. Output data are synchronized to this clock. If EXT/INT is low, DATACLK transmits 16 pulses after each conversion, and then remains low between conversions.  |  |  |  |  |  |
| DGND             | 14                                 | -   | Digital ground   |  |  |  |  |  |
| EXT/INT          | 13                                 | ı   | Selects external or internal clock for transmitting data. If high, data are output synchronized to the clock input on DATACLK. If low, a convert command initiates the transmission of the data from the previous conversion, along with 16 clock pulses output on DATACLK.  |  |  |  |  |  |
| NC               | 5, 8, 10, 11,<br>18, 20, 22,<br>23 | -   | Not connected  |  |  |  |  |  |
| PWRD             | 26                                 | I   | Power down input. If high, conversions are inhibited and power consumption is significantly reduced. Results from the previous conversion are maintained in the output shift register.   |  |  |  |  |  |
| R/C              | 21                                 | I   | Read/convert input. With $\overline{CS}$ low, a falling edge on R/ $\overline{C}$ puts the internal sample-and-hold into the hold state and starts a conversion. When EXT/ $\overline{INT}$ is low, this also initiates the transmission of the data results from the previous conversion. If EXT/ $\overline{INT}$ is high, a rising edge on R/ $\overline{C}$ with $\overline{CS}$ low, or a falling edge on $\overline{CS}$ with R/ $\overline{C}$ high, initiates the transmission of data from the previous conversion. |  |  |  |  |  |
| REF              | 7                                  | I/O | Reference input/output. Outputs internal 4.096V reference. Can also be driven by external system reference. In both cases, bypass to ground with a 2.2μF tantalum capacitor.   |  |  |  |  |  |
| R1 <sub>IN</sub> | 1                                  | Ι   | Analog input. See Table 2 for input range connections.   |  |  |  |  |  |
| R2 <sub>IN</sub> | 3                                  | -   | Analog input. See Table 2 for input range connections.   |  |  |  |  |  |
| R3 <sub>IN</sub> | 4                                  | Ι   | Analog input. See Table 2 for input range connections.   |  |  |  |  |  |
| SB/BTC           | 12                                 | -   | Select straight binary or binary two's complement data output format. If high, data are output in a straight binary format. If low, data are output in a binary two's complement format.   |  |  |  |  |  |
| SYNC             | 15                                 | 0   | Sync output. This pin is used to supply a data synchronization pulse when the EXT level is high and at least one external clock pulse has occurred when not in the read mode. See the <i>External DATACLK</i> section for the external clock mode description.   |  |  |  |  |  |
| TAG              | 19                                 | Ι   | Tag input for use in the external clock mode. If EXT is high, digital data input from TAG is output on DATA with a delay that depends on the external clock mode. See Figure 8 and Figure 9.   |  |  |  |  |  |
| $V_{ANA}$        | 27                                 | _   | Analog supply input. Nominally +5V. Connect directly to pin 20, and decouple to ground with $0.1\mu F$ ceramic and $10\mu F$ tantalum capacitors.  |  |  |  |  |  |
| $V_{DIG}$        | 28                                 | I   | Digital supply input. Connect directly to pin 19.  |  |  |  |  |  |

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## TIMING REQUIREMENTS, $T_A = -40$ °C to +85°C

|                                      | PARAMETER   | MIN | TYP | MAX | UNIT |
|--------------------------------------|---|-----|-----|-----|------|
| t <sub>w1</sub>                      | Pulse duration, convert   | 40  |     |     | ns   |
| t <sub>d1</sub>                      | Delay time, BUSY from R/C low   |     | 6   | 20  | ns   |
| t <sub>w2</sub>                      | Pulse duration, BUSY low  |     |     | 2.2 | μS   |
| t <sub>d2</sub>                      | Delay time, BUSY, after end of conversion   |     | 5   |     | ns   |
| t <sub>d3</sub>                      | Delay time, aperture  |     | 5   |     | ns   |
| t <sub>conv</sub>                    | Conversion time   |     |     | 2.2 | μS   |
| t <sub>acq</sub>                     | Acquisition time  | 1.8 |     |     | μS   |
| t <sub>conv</sub> + t <sub>acq</sub> | Cycle time  |     |     | 4   | μS   |
| t <sub>d4</sub>                      | Delay time, R/C Low to internal DATACLK output  |     | 270 |     | ns   |
| t <sub>c1</sub>                      | Cycle time, internal DATACLK  |     | 110 |     | ns   |
| t <sub>d5</sub>                      | Delay time, data valid to internal DATACLK high   | 15  | 35  |     | ns   |
| t <sub>d6</sub>                      | Delay time, data valid after internal DATACLK low   | 20  | 35  |     | ns   |
| t <sub>c2</sub>                      | Cycle time, external DATACLK  | 35  |     |     | ns   |
| t <sub>w3</sub>                      | Pulse duration, external DATACLK high   | 15  |     |     | ns   |
| t <sub>w4</sub>                      | Pulse duration, external DATACLK low  | 15  |     |     | ns   |
| t <sub>su1</sub>                     | Setup time, R/C rise/fall to external DATACLK high  | 15  |     |     | ns   |
| t <sub>su2</sub>                     | Setup time, R/C transition to CS transition   | 10  |     |     | ns   |
| t <sub>d7</sub>                      | Delay time, SYNC, after external DATACLK high   | 3   |     | 35  | ns   |
| t <sub>d8</sub>                      | Delay time, data valid from external DATACLK high   | 2   |     | 13  | ns   |
| t <sub>d9</sub>                      | Delay time, $\overline{\text{CS}}$ rising edge to external DATACLK rising edge                  | 10  |     |     | ns   |
| t <sub>d10</sub>                     | Delay time, previous data available after $\overline{\text{CS}}$ , R/ $\overline{\text{C}}$ low | 2   |     |     | μS   |
| t <sub>su3</sub>                     | Setup time, BUSY transition to first external DATACLK   | 5   |     |     | ns   |
| t <sub>d11</sub>                     | Delay time, final external DATACLK to BUSY rising edge  |     |     | 1   | μS   |
| t <sub>su4</sub>                     | Setup time, TAG valid   | 0   |     |     | ns   |
| t <sub>h1</sub>                      | Hold time, TAG valid  | 2   |     |     | ns   |

### **TIMING DIAGRAMS**

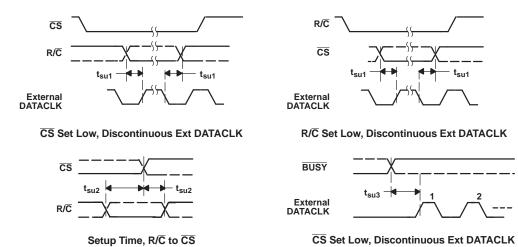


Figure 1. Critical Timing

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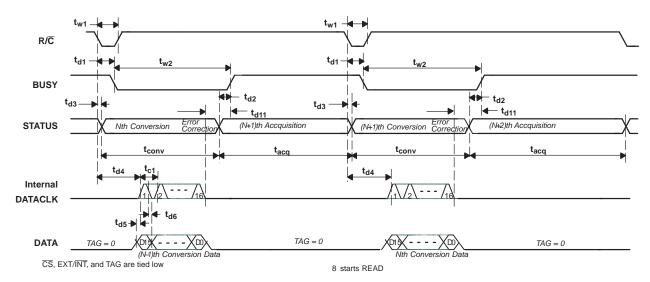


Figure 2. Basic Conversion Timing: Internal DATACLK (Read Previous Data During Conversion)

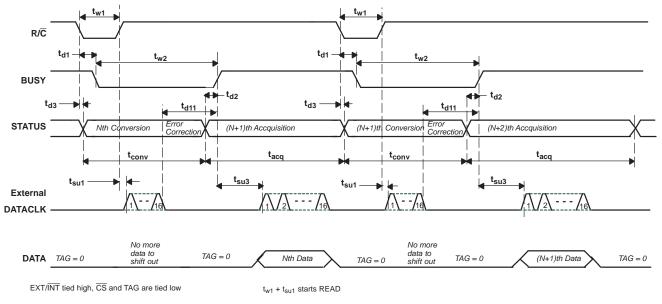


Figure 3. Basic Conversion Timing: External DATACLK

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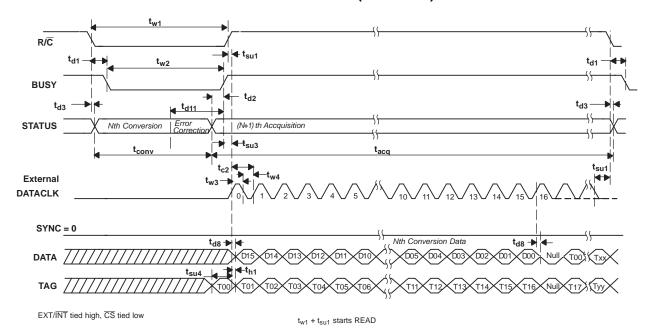


Figure 4. Read After Conversion (Discontinuous External DATACLK)

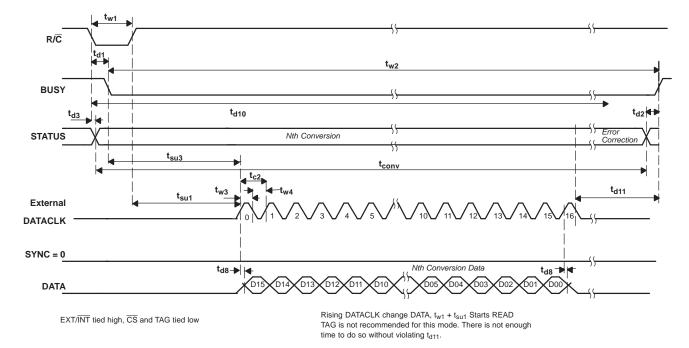


Figure 5. Read During Conversion (Discontinuous External DATACLK)

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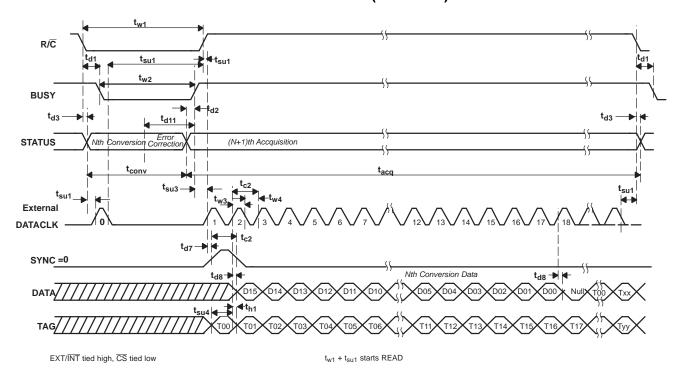


Figure 6. Read After Conversion With SYNC (Discontinuous External DATACLK)

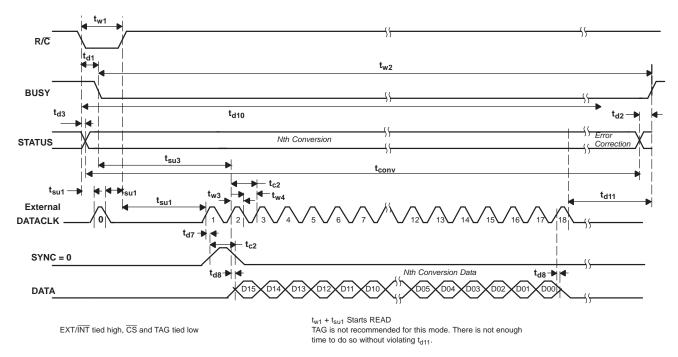


Figure 7. Read During Conversion With SYNC (Discontinuous External DATACLK)

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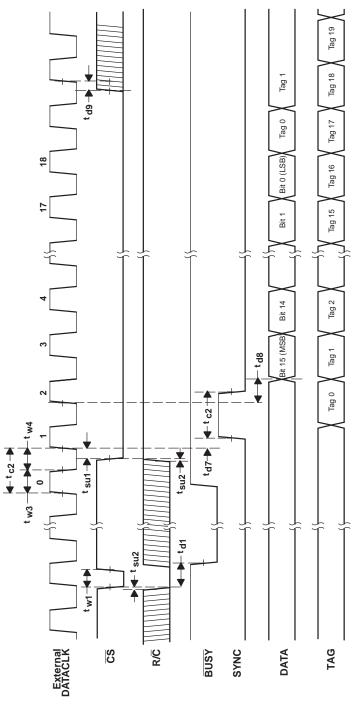


Figure 8. Conversion and Read Timing with Continuous External DATACLK (EXT/INT Tied High) Read After Conversions (Not Recommended)



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### **TIMING DIAGRAMS (continued)**

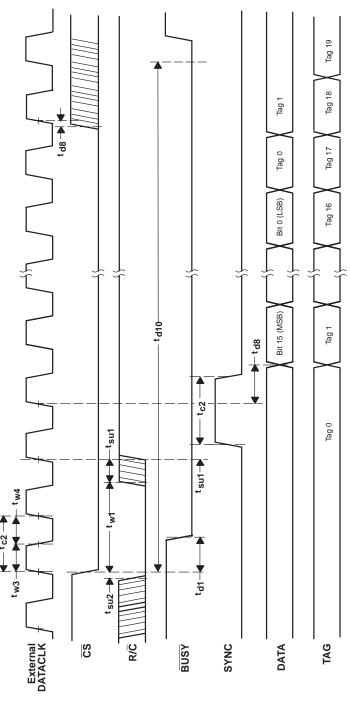


Figure 9. Conversion and Read Timing with Continuous External DATACLK (EXT/INT Tied High) Read Previous Conversion Results During Conversion (Not Recommended)

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8000

7000

6000

5000

4000

3000

2000

1000

65530

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#### TYPICAL CHARACTERISTICS

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#### FREE-AIR TEMPERATURE

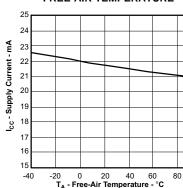


Figure 11.

#### INTERNAL VOLTAGE REFERENCE vs

## FREE-AIR TEMPERATURE

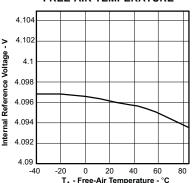


Figure 12.

## **BIPOLAR ZERO ERROR**

65532

Code

Figure 10.

2

65534

65533

**HISTOGRAM** 

6930

### FREE-AIR TEMPERATURE

712

65531

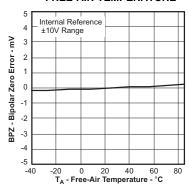


Figure 13.

## **POSITIVE FULL-SCALE ERROR** FREE-AIR TEMPERATURE

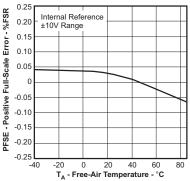


Figure 14.

# **NEGATIVE FULL-SCALE ERROR**

### FREE-AIR TEMPERATURE

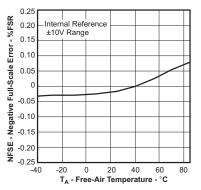


Figure 15.

## **POSITIVE FULL-SCALE ERROR** FREE-AIR TEMPERATURE

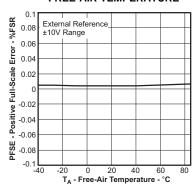


Figure 16.

#### **NEGATIVE FULL-SCALE ERROR** vs

## FREE-AIR TEMPERATURE

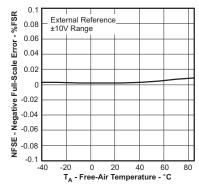


Figure 17.

### SPURIOUS FREE DYNAMIC RANGE

#### FREE-AIR TEMPERATURE

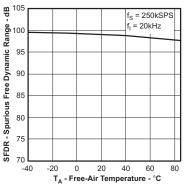


Figure 18.

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## **TYPICAL CHARACTERISTICS (continued)**

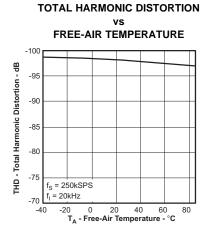


Figure 19.

# SIGNAL-TO-NOISE RATIO FREE-AIR TEMPERATURE

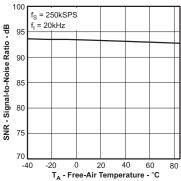


Figure 20.

**SIGNAL-TO-NOISE AND** DISTORTION FREE-AIR TEMPERATURE

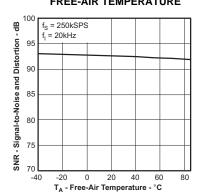


Figure 21.



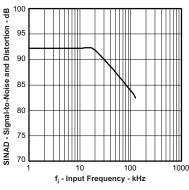


Figure 22.

### SIGNAL-TO-NOISE RATIO vs

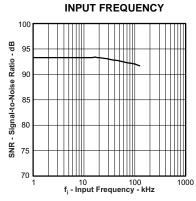


Figure 23.

## SPURIOUS FREE DYNAMIC RANGE



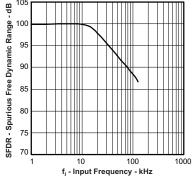
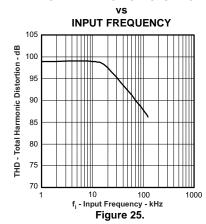


Figure 24.

#### **TOTAL HARMONIC DISTORTION**



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### TYPICAL CHARACTERISTICS (continued)

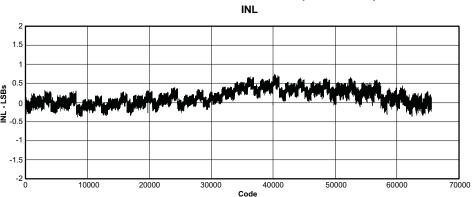


Figure 26.

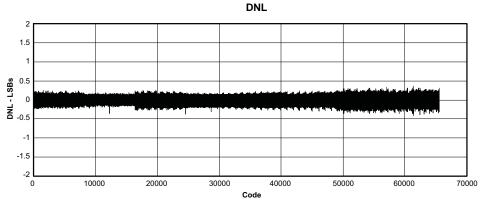


Figure 27.

#### BASIC OPERATION

Two signals control conversion in the ADS8519:  $\overline{CS}$  and  $R/\overline{C}$ . These two signals are internally ORed together. To start a conversion, the chip must be selected ( $\overline{CS}$  low) and the conversion signal must be active ( $R/\overline{C}$  low). Either signal can be brought low first. Conversion starts on the falling edge of the second signal.  $\overline{BUSY}$  goes low when conversion starts and returns  $\overline{high}$  after the data from that conversion are shifted into the internal storage register. Sampling begins when  $\overline{BUSY}$  goes high.

To reduce the number of control pins,  $\overline{CS}$  can be tied low permanently. The R/ $\overline{C}$  pin then controls conversion and data reading exclusively. In the external clock mode, this configuration means that the ADS8519 clocks out data whenever R/ $\overline{C}$  is brought high and the external clock is active. In the internal clock mode, data are clocked out every convert cycle, regardless of the states of  $\overline{CS}$  and R/ $\overline{C}$ . The ADS8519 provides a TAG input for cascading multiple converters together.

#### **READING DATA**

The conversion result is available as soon as BUSY returns to high; therefore, data always represent the conversion previously completed, even when it is read during a conversion. The ADS8519 outputs serial data in either straight binary or binary two's complement format. The SB/BTC pin controls the format, data are shifted out MSB first. The first conversion immediately following a power-up does not produce a valid conversion result.

Data can be clocked out with either the internally-generated clock or with an external clock. The EXT/INT pin controls this function. If an external clock is used, the TAG input can be used to daisy-chain multiple ADS8519 data pins together.



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#### INTERNAL DATACLK

In the internal clock mode, data for the previous conversion are clocked out during each conversion period. The internal data clock is synchronized to the internal conversion clock so that it does not interfere with the conversion process.

The DATACLK pin becomes an output when EXT/ $\overline{\text{INT}}$  is low. 16 clock pulses are generated at the beginning of each conversion after timing  $t_{d4}$  is satisfied (that is, previous conversion results can only be read during the current conversion). DATACLK returns to low when it is inactive. The 16 bits of serial data are shifted out of the DATA pin synchronous to this clock, with each bit available on a rising and then a falling edge. The DATA pin then returns to the state of the TAG pin input sensed at the start of transmission.

#### **EXTERNAL DATACLK**

The external clock mode offers several ways to retrieve conversion results. However, care must be taken to avoid corrupting the data because the external clock cannot be synchronized to the internal conversion clock.

When EXT/ $\overline{\text{INT}}$  is set high, the R/ $\overline{\text{C}}$  and  $\overline{\text{CS}}$  signals control the read state. When the read state is initiated, the result from the previously completed conversion is shifted out of the DATA pin synchronous to the external clock that is connected to the DATACLK pin. Each bit is available on a falling and then a rising edge. The maximum external clock speed of 28.5MHz allows data to be shifted out quickly either at the beginning of conversion or the beginning of sampling.

There are several modes of operation available when using an external clock. It is recommended that the external clock run only while reading data. This mode is the discontinuous clock mode. Because the external clock is not synchronized to the internal clock that controls conversion, slight changes in the external clock can cause conflicts that can corrupt the conversion process. Specifications with a continuously running external clock cannot be ensured. It is especially important that the external clock does not run during the second half of the conversion cycle (approximately the time period specified by  $t_{d11}$ ; see the *Timing Requirements* table).

In the discontinuous clock mode, data can be read during conversion or during sampling, with or without a SYNC pulse. Data read during a conversion must meet the  $t_{d11}$  timing specification. Data read during sampling must be complete before starting a conversion.

Whether reading during sampling or during conversion, a SYNC pulse is generated whenever at least one rising edge of the external clock occurs while the device is not in the read state. In the *Discontinuous External Clock with SYNC* mode, a SYNC pulse follows the first rising edge after the read command. Data are shifted out after the SYNC pulse. The first rising clock edge after the read command generates a SYNC pulse. The SYNC pulse can be detected on the next falling edge and then the next rising edge. Successively, each bit can be read first on the falling edge and then on the next rising edge. Thus, 17 clock pulses after the read command are required to read on the falling edge; 18 clock pulses are necessary to read on the rising edge.

If the clock is entirely inactive when not in the read state, no SYNC pulse is generated. In this case, the first rising clock edge shifts out the MSB. The MSB can be read on the first falling edge or on the next rising edge. In this *Discontinuous External Clock with No SYNC* mode, 16 clocks are necessary to read the data on the falling edge and 17 clocks for reading on the rising edge. Data always represent the conversion already completed. Table 1 summarizes the required DATACLK pulses.

**Table 1. DATACLK Pulses** 

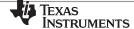
|                                 | DATACLK PULS | SES REQUIRED |
|---------------------------------|--------------|--------------|
| DESCRIPTION                     | WITH SYNC    | WITHOUT SYNC |
| Read on falling edge of DATACLK | 17           | 16           |
| Read on rising edge of DATACLK  | 18           | 17           |

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#### **TAG FEATURE**

The TAG feature allows the data from multiple ADS8519 converters to be read on a single serial line. The converters are cascaded together using the DATA pins as outputs and the TAG pins as inputs, as illustrated in Figure 28. The DATA pin of the last converter drives the processor serial data input. Data are then shifted through each converter, synchronous to the externally supplied data clock, onto the serial data line. The internal clock cannot be used for this configuration.

The preferred timing uses the discontinuous, external data clock during the sampling period. Data must be read during the sampling period because there is not sufficient time to read data from multiple converters during a conversion period without violating the t<sub>d11</sub> constraint (see External DATACLK section). The sampling period must be sufficiently long to allow all data words to be read before starting a new conversion.

In Figure 28, note that a null bit separates the data word from each converter. The state of the DATA pin at the end of a read cycle reflects the state of the TAG pin at the start of the cycle. This condition is true in all read modes, including the internal clock mode. For example, when a single converter is used in the internal clock mode, the state of the TAG pin determines the state of the DATA pin after all 16 bits have shifted out. When multiple converters are cascaded together, this state forms the null bit that separates the words. Thus, with the TAG pin of the first converter grounded as shown in Figure 28, the null bit becomes a zero between each data word.

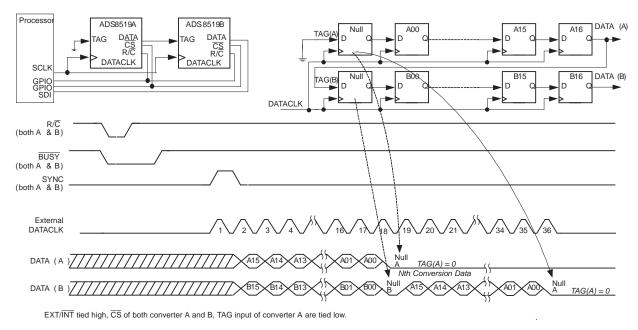


Figure 28. Timing of TAG Feature With Single Conversion (Using External DATACLK)

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#### **ANALOG INPUTS**

The ADS8519 has three analog input ranges, as shown in Table 2. The offset specification is factory-calibrated with internal resistors. The gain specification is factory-calibrated with 0.1%, 0.25W, external resistors, as shown in Figure 29 and Figure 30. The external resistors can be omitted if a larger gain error is acceptable or if using software calibration. The hardware trim circuitry shown in Figure 29 and Figure 30 can reduce the error to zero.

Table 2. Input Range Connections (see Figure 29 and Figure 30 for complete information)

| ANALOG<br>INPUT<br>RANGE | CONNECT R1 <sub>IN</sub> TO | CONNECT R2 <sub>IN</sub> TO | CONNECT R3 <sub>IN</sub> TO | IMPEDANCE |
|--------------------------|-----------------------------|-----------------------------|-----------------------------|-----------|
| ±10V                     | V <sub>IN</sub>             | AGND                        | CAP                         | 8.88kΩ    |
| ±10V                     | AGND                        | $V_{IN}$                    | CAP                         | 8.88kΩ    |
| ±5V                      | V <sub>IN</sub>             | V <sub>IN</sub>             | CAP                         | 6.08kΩ    |
| 0V to 8.192V             | AGND                        | AGND                        | V <sub>IN</sub>             | 5.95kΩ    |

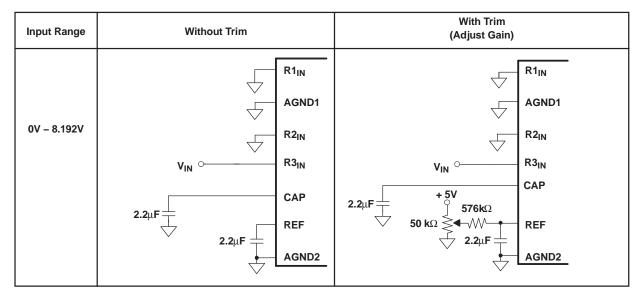
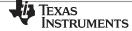


Figure 29. Offset/Gain Circuits for Unipolar Input Ranges

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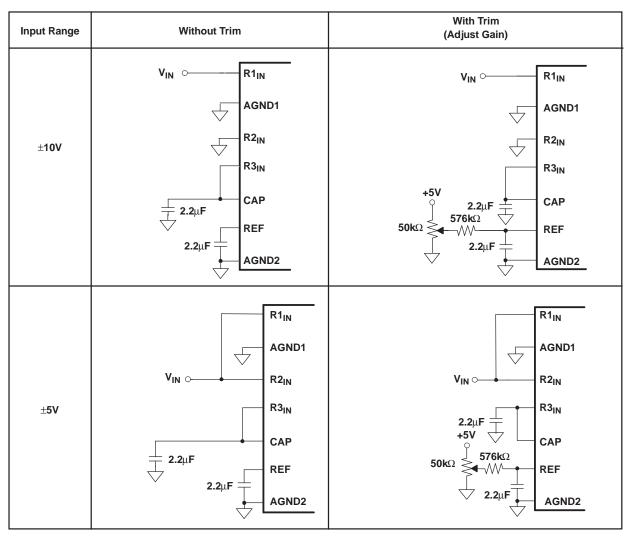


Figure 30. Offset/Gain Circuits for Bipolar Input Ranges

Analog input pins  $R1_{IN}$ ,  $R2_{IN}$ , and  $R3_{IN}$  have  $\pm 25V$  overvoltage protection. The input signal must be referenced to AGND1. This referencing minimizes the ground-loop problem typical to analog designs. The analog input should be driven by a low-impedance source. A typical driving circuit using the OPA627 or OPA132 is shown in Figure 30.

The ADS8519 can operate with its internal 4.096V reference or an external reference. An external reference connected to pin 7 (REF) bypasses the internal reference. The external reference must drive the  $4k\Omega$  resistor that separates pin 6 from the internal reference (see the illustration on page 1). The load varies with the difference between the internal and external reference voltages. The external reference voltage can vary from 3.9V to 4.2V. The internal reference is approximately 4.096V. The reference, whether internal or external, is buffered internally with the output on pin 6 (CAP).

The ADS8519 is factory-tested with  $2.2\mu F$  capacitors connected to pin 6 (CAP) and pin 7 (REF). Each capacitor should be placed as close as possible to its pin. The capacitor on pin 7 band-limits the internal reference noise. A smaller capacitor can be used, but it may degrade SNR and SINAD The capacitor on pin 6 stabilizes the reference buffer and provides switching charge to the CDAC during conversion. Capacitors smaller than  $1\mu F$  may cause the buffer to become unstable and not hold sufficient charge for the CDAC. The parts are tested to specifications with  $2.2\mu F$ , so larger capacitors are not necessary. The equivalent series resistance (ESR) of these compensation capacitors is also critical. Keep the total ESR under  $3\Omega$ . See the *Typical Characteristics* section concerning how ESR affects performance.

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Neither the internal reference nor the buffer should be used to drive an external load. Such loading can degrade performance. Any load on the internal reference causes a voltage drop across the  $4k\Omega$  resistor and affects gain. The internal buffer is capable of driving ±2mA loads, but any load can cause perturbations of the reference at the CDAC, degrading performance. It should be pointed out that, unlike other devices with a similar input structure, the ADS8519 does not require a second high-speed amplifier used as a buffer to isolate the CAP pin from the signal-dependent current in the R3<sub>IN</sub> pin, but can tolerate it if one does exist.

The external reference voltage can vary from 3.9V to 4.2V. The reference voltage determines the size of the least significant bit (LSB). The larger reference voltages produce a larger LSB, which can improve SNR. Smaller reference voltages can degrade SNR.

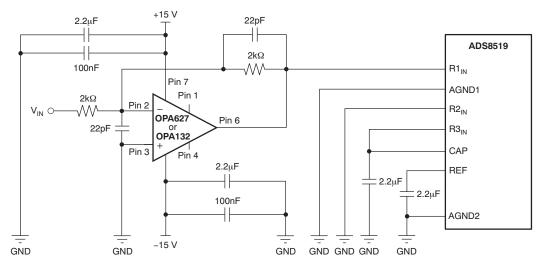


Figure 31. Typical Driving Circuitry (±10V, No Trim)

#### BUSY SB/BTC SPECIFIC FUNCTION CS R/C EXT/INT DATACLK **PWRD OPERATION** O 0 Output Initiate conversion and 1 > 0Initiates conversion n Data from conversion n - 1 output data using internal clocked out on DATA synchronized to 16 clock 1 > 0 0 Output 0 1 0 Х clock pulses output on DATACLK. 1 > 0 0 1 0 Input Х Initiates conversion n. 1 0 0 1 > 0 1 Input Initiates conversion n. Initiate conversion and Outputs data with or without SYNC pulse. See the output data using external 1 > 0 1 1 1 Input х Х Reading Data section. 1 > 0 1 0 1 Input 0 х Outputs data with or without SYNC pulse. See Reading Data section.

Input

Х

Х

Х

0

0

0

1

х

х

х

Х

0

1

format.

**Table 3. Control Truth Table** 

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0

0

х

Х

0 > 1

0

Х

Х

0

0 > 1

Х

Х

Х

1

Х

Х

х

Х

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This is an acceptable condition.

Analog circuitry powered. Conversion can

conversion maintained in output registers Serial data are output in binary twos complement

Analog circuitry disabled. Data from previous

Serial data are output in straight binary format.

20

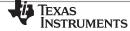
No actions

Power down

Selecting output format

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### Table 4. Output Codes and Ideal Input Voltages

| DESCRIPTION                 | ANALOG INPUT RANGE |           |              | DIGITAL OUTPUT                         |          |                               |          |  |  |
|-----------------------------|--------------------|-----------|--------------|--|----------|-------------------------------|----------|--|--|
| Full-scale range            | ±10V               | ±5V       | 0V to 8.192V | BINARY TWOS COMPLEMENT<br>(SB/BTC LOW) |          | STRAIGHT BINA<br>(SB/BTC HIGH |          |  |  |
| Least significant bit (LSB) | 305μV              | 153μV     | 125μV        | BINARY CODE                            | HEX CODE | BINARY CODE                   | HEX CODE |  |  |
| +Full-scale<br>(FS – 1LSB)  | 9.999695V          | 4.999847V | 8.191875V    | 0111 1111 1111 1111                    | 7FFF     | 1111 1111 1111 1111           | FFFF     |  |  |
| Midscale                    | 0V                 | 0V        | 4.096V       | 0000 0000 0000 0000                    | 0000     | 1000 0000 0000 0000           | 8000     |  |  |
| One LSB below midscale      | –305μV             | 153μV     | 4.095975V    | 1111 1111 1111 1111                    | FFFF     | 0111 1111 1111 1111           | 7FFF     |  |  |
| -Full scale                 | -10V               | -5V       | 0V           | 1000 0000 0000 0000                    | 8000     | 0000 0000 0000 0000           | 0000     |  |  |

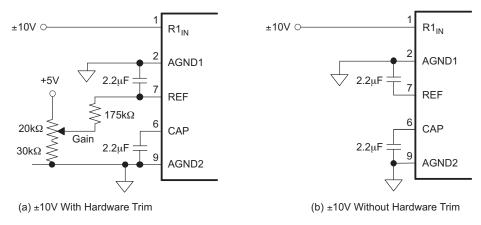


Figure 32. Gain Adjust Trim

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| SLAS462D - | -JUNE | 2007- | REVISED | <b>SEPTEMBER</b> | 2010 |
|------------|-------|-------|---------|------------------|------|
|------------|-------|-------|---------|------------------|------|

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### **REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| С | hanges from Revision C (June, 2009) to Revision D  | Page |
|---|--|------|
| • | Changed input/output description for SB/BTC pin (pin 12)   | 6    |
| С | hanges from Revision B (October, 2008) to Revision C   | Page |
| • | Changed external reference voltage range min value from 2.5V to 3.9V and max value from 4.1V to 4.2V           | 3    |
| • | Corrected pin names and numbers in paragraphs discussing internal and external reference operation and factory |      |



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PACKAGE OPTION ADDENDUM

10-Jun-2014

### **PACKAGING INFORMATION**

Lead/Ball Finish Device Marking Orderable Device Status Package Type Package Pins Package Eco Plan MSL Peak Temp Op Temp (°C) Samples Qty Drawing (1) (2) (6) (3) ACTIVE SSOF CU NIPDAU Level-2-260C-1 YEAR ADS8519I ADS8519IBDB 28 Green (RoHS DB 50 -40 to 85 Samples & no Sb/Br) CU NIPDAU ADS8519I ADS8519IBDBG4 **ACTIVE** SSOP DB 50 Green (RoHS Level-2-260C-1 YEAR 28 -40 to 85 & no Sb/Br) В ADS8519IBDBR ACTIVE SSOP DB 28 2000 Green (RoHS CU NIPDAU Level-2-260C-1 YEAR -40 to 85 ADS8519I Samples & no Sb/Br) ADS8519IDB ACTIVE SSOP DB 28 50 Green (RoHS CU NIPDAU Level-2-260C-1 YEAR -40 to 85 ADS8519I Samples & no Sb/Br) SSOP ADS8519IDBR DB CU NIPDAU Level-2-260C-1 YEAR ADS8519I ACTIVE 28 Green (RoHS & no Sb/Br)

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that

lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device

(6) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "--" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device

Addendum-Page 1



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PACKAGE OPTION ADDENDUM

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(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish

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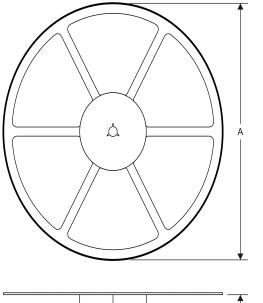


## **PACKAGE MATERIALS INFORMATION**

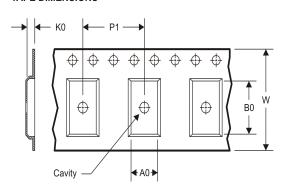
14-Jul-2012 www.ti.com

#### TAPE AND REEL INFORMATION

#### **REEL DIMENSIONS**



#### **TAPE DIMENSIONS**



| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |



#### TAPE AND REEL INFORMATION

\*All dimensions are nominal

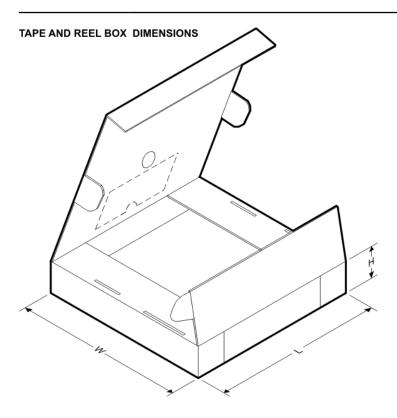
| Device       | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| ADS8519IBDBR | SSOP            | DB                 | 28 | 2000 | 330.0                    | 16.4                     | 8.1        | 10.4       | 2.5        | 12.0       | 16.0      | Q1               |
| ADS8519IDBR  | SSOP            | DB                 | 28 | 2000 | 330.0                    | 16.4                     | 8.1        | 10.4       | 2.5        | 12.0       | 16.0      | Q1               |

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## **PACKAGE MATERIALS INFORMATION**

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### \*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS8519IBDBR | SSOP         | DB              | 28   | 2000 | 367.0       | 367.0      | 38.0        |
| ADS8519IDBR  | SSOP         | DB              | 28   | 2000 | 367.0       | 367.0      | 38.0        |



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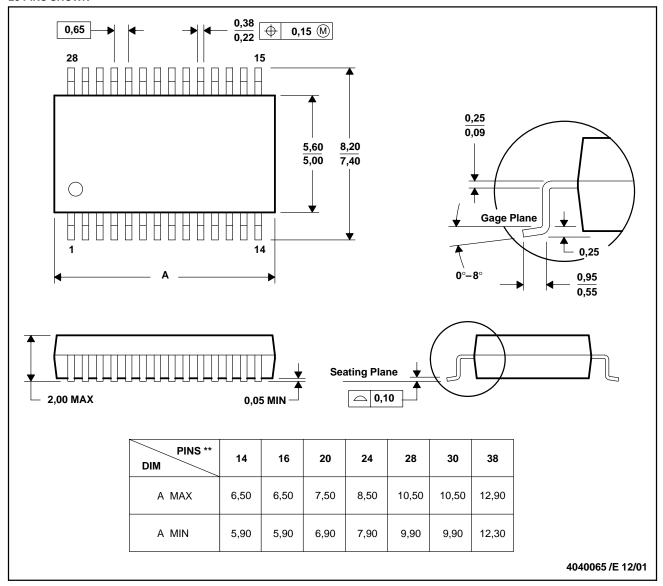
### MECHANICAL DATA

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

### DB (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE

#### 28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150





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